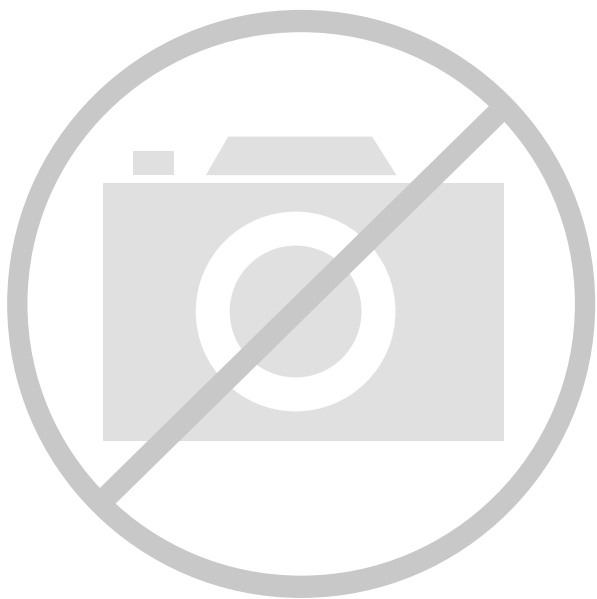




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	2016
Number of Logic Elements/Cells	-
Total RAM Bits	18432
Number of I/O	168
Number of Gates	125000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	324-BGA
Supplier Device Package	324-FBGA (19x19)
Purchase URL	https://www.e-xfl.com/product-detail/microsemi/ax125-1fgg324

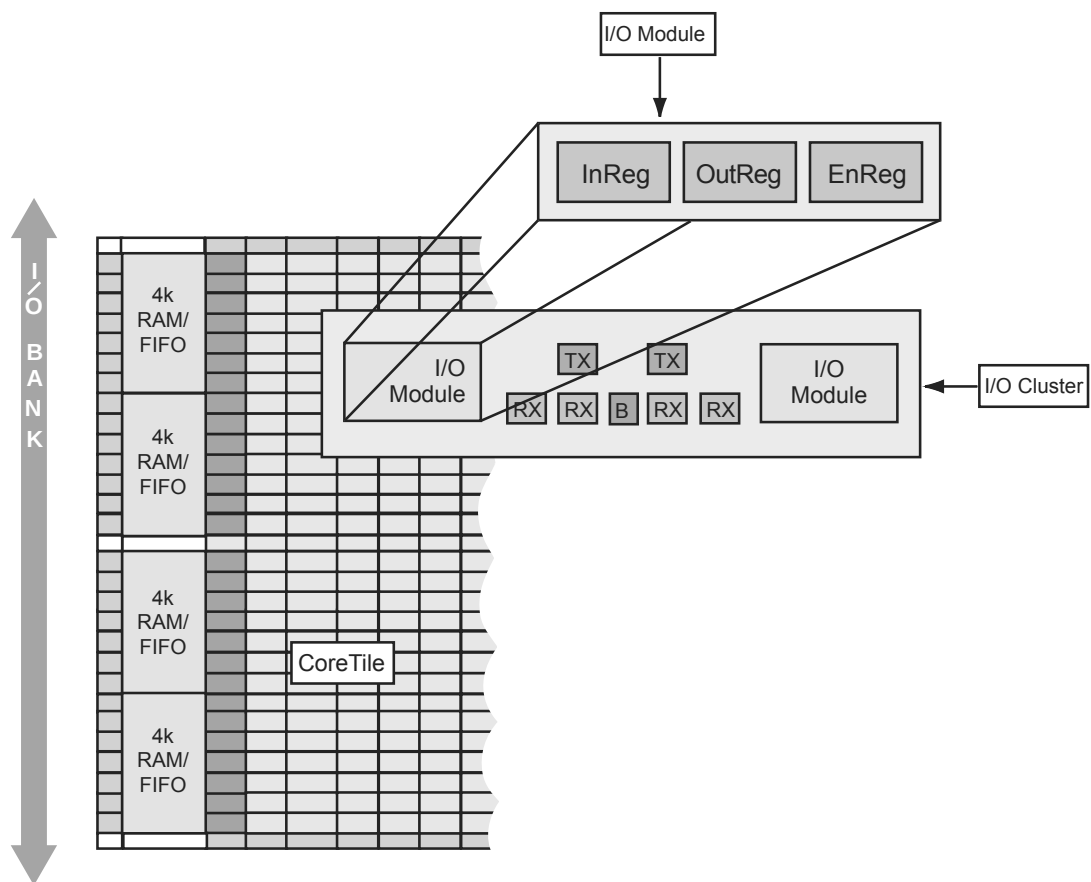


Figure 1-7 • I/O Cluster Arrangement

Routing

The AX hierarchical routing structure ties the logic modules, the embedded memory blocks, and the I/O modules together (Figure 1-8 on page 1-6). At the lowest level, in and between SuperClusters, there are three local routing structures: FastConnect, DirectConnect, and CarryConnect routing. DirectConnects provide the highest performance routing inside the SuperClusters by connecting a C-cell to the adjacent R-cell. DirectConnects do not require an antifuse to make the connection and achieve a signal propagation time of less than 0.1 ns.

FastConnects provide high-performance, horizontal routing inside the SuperCluster and vertical routing to the SuperCluster immediately below it. Only one programmable connection is used in a FastConnect path, delivering a maximum routing delay of 0.4 ns.

CarryConnects are used for routing carry logic between adjacent SuperClusters. They connect the FCO output of one two-bit, C-cell carry logic to the FCI input of the two-bit, C-cell carry logic of the SuperCluster below it. CarryConnects do not require an antifuse to make the connection and achieve a signal propagation time of less than 0.1 ns.

The next level contains the core tile routing. Over the SuperClusters within a core tile, both vertical and horizontal tracks run across rows or columns, respectively. At the chip level, vertical and horizontal tracks extend across the full length of the device, both north-to-south and east-to-west. These tracks are composed of highway routing that extend the entire length of the device (segmented at core tile boundaries) as well as segmented routing of varying lengths.

Table 2-8 • I/O Standards Supported by the Axcelerator Family

I/O Standard	Input/Output Supply Voltage (VCCI)	Input Reference Voltage (VREF)	Board Termination Voltage (VTT)
LVTTL	3.3	N/A	N/A
LVC MOS 2.5 V	2.5	N/A	N/A
LVC MOS 1.8 V	1.8	N/A	N/A
LVC MOS 1.5 V (JDEC8-11)	1.5	N/A	N/A
3.3V PCI/PCI-X	3.3	N/A	N/A
GTL+ 3.3 V	3.3	1.0	1.2
GTL+ 2.5 V*	2.5	1.0	1.2
HSTL Class 1	1.5	0.75	0.75
SSTL3 Class 1 and II	3.3	1.5	1.5
SSTL2 Class1 and II	2.5	1.25	1.25
LVDS	2.5	N/A	N/A
LVPECL	3.3	N/A	N/A

Note: *2.5 V GTL+ is not supported across the full military temperature range.

Table 2-9 • Supply Voltages

VCCA	VCCI	Input Tolerance	Output Drive Level
1.5 V	1.5 V	3.3 V	1.5 V
1.5 V	1.8 V	3.3 V	1.8 V
1.5 V	2.5 V	3.3 V	2.5 V
1.5 V	3.3 V	3.3 V	3.3 V

Table 2-10 • I/O Features Comparison

I/O Assignment	Clamp Diode	Hot Insertion	5 V Tolerance	Input Buffer	Output Buffer
LVTTL	No	Yes	Yes ¹	Enabled/Disabled	
3.3 V PCI, 3.3 V PCI-X	Yes	No	Yes ^{1, 2}	Enabled/Disabled	
LVC MOS 2.5 V	No	Yes	No	Enabled/Disabled	
LVC MOS 1.8 V	No	Yes	No	Enabled/Disabled	
LVC MOS 1.5 V (JESD8-11)	No	Yes	No	Enabled/Disabled	
Voltage-Referenced Input Buffer	No	Yes	No	Enabled/Disabled	
Differential, LVDS/LVPECL, Input	No	Yes	No	Enabled	Disabled ³
Differential, LVDS/LVPECL, Output	No	Yes	No	Disabled	Enabled ⁴

Notes:

1. Can be implemented with an IDT bus switch.
2. Can be implemented with an external resistor.
3. The OE input of the output buffer must be deasserted permanently (handled by software).
4. The OE input of the output buffer must be asserted permanently (handled by software).

I/O Standard Electrical Specifications

Table 2-18 • Input Capacitance

Symbol	Parameter	Conditions	Min.	Max.	Units
C_{IN}	Input Capacitance	$V_{IN} = 0, f = 1.0 \text{ MHz}$		10	pF
C_{INCLK}	Input Capacitance on HCLK and RCLK Pin	$V_{IN} = 0, f = 1.0 \text{ MHz}$		10	pF

Table 2-19 • I/O Input Rise Time and Fall Time*

Input Buffer	Input Rise/Fall Time (min.)	Input Rise/Fall Time (max.)
LVTTTL	No Requirement	50 ns
LVC MOS 2.5V	No Requirement	50 ns
LVC MOS 1.8V	No Requirement	50 ns
LVC MOS 1.5V	No Requirement	50 ns
PCI	No Requirement	50 ns
PCIX	No Requirement	50 ns
GTL+	No Requirement	50 ns
HSTL	No Requirement	50 ns
SSTL2	No Requirement	50 ns
HSTL3	No Requirement	50 ns
LVDS	No Requirement	50 ns
LVPECL	No Requirement	50 ns

*Note: *Input Rise/Fall time applies to all inputs, be it clock or data. Inputs have to ramp up/down linearly, in a monotonic way. Glitches or a plateau may cause double clocking. They must be avoided. For output rise/fall time, refer to the IBIS models for extraction.*

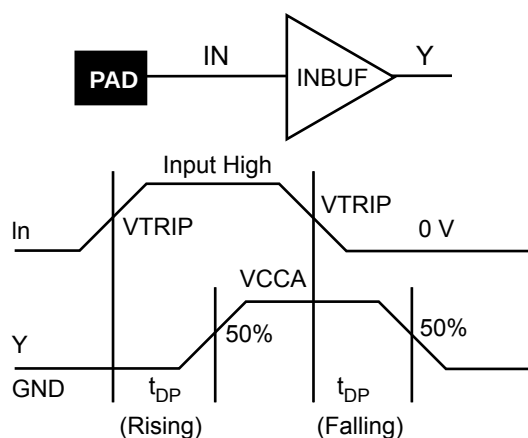


Figure 2-9 • Input Buffer Delays

3.3 V LVTTTL

Low-Voltage Transistor-Transistor Logic is a general purpose standard (EIA/JESD) for 3.3 V applications. It uses an LVTTTL input buffer and push-pull output buffer.

Table 2-20 • DC Input and Output Levels

VIL		VIH		VOL	VOH	IOL	IOH
Min., V	Max., V	Min., V	Max., V	Max., V	Min., V	mA	mA
−0.3	0.8	2.0	3.6	0.4	2.4	24	−24

AC Loadings

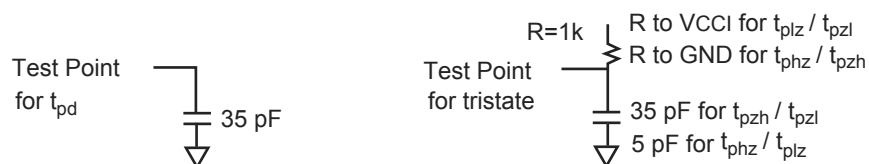


Figure 2-15 • AC Test Loads

Table 2-21 • AC Waveforms, Measuring Points, and Capacitive Load

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ) (V)	C _{load} (pF)
0	3.0	1.40	N/A	35

Note: * Measuring Point = VTRIP

Timing Characteristics

Table 2-22 • 3.3 V LVTTL I/O Module

Worst-Case Commercial Conditions $V_{CCA} = 1.425\text{ V}$, $V_{CCI} = 3.0\text{ V}$, $T_J = 70^\circ\text{C}$

		–2 Speed		–1 Speed		Std Speed		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Units
LVTTL Output Drive Strength = 1 (8 mA) / Low Slew Rate								
t_{DP}	Input Buffer		1.68		1.92		2.26	ns
t_{PY}	Output Buffer		14.28		16.27		19.13	ns
t_{ENZL}	Enable to Pad Delay through the Output Buffer—Z to Low		15.25		17.37		20.42	ns
t_{ENZH}	Enable to Pad Delay through the Output Buffer—Z to High		14.26		16.24		19.09	ns
t_{ENLZ}	Enable to Pad Delay through the Output Buffer—Low to Z		1.56		1.57		1.58	ns
t_{ENHZ}	Enable to Pad Delay through the Output Buffer—High to Z		1.95		1.96		1.97	ns
t_{IOCLKQ}	Sequential Clock-to-Q for the I/O Input Register		0.67		0.77		0.90	ns
t_{IOCLKY}	Clock-to-output Y for the I/O Output Register and the I/O Enable Register		0.67		0.77		0.90	ns
t_{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t_{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t_{HD}	Data Input Hold		0.00		0.00		0.00	ns
t_{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t_{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t_{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t_{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t_{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t_{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t_{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t_{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

Table 2-22 • 3.3 V LVTTTL I/O Module

Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C (continued)

		–2 Speed		–1 Speed		Std Speed		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Units
LVTTTL Output Drive Strength = 2 (12 mA) / Low Slew Rate								
t _{DP}	Input Buffer		1.68		1.92		2.26	ns
t _{PY}	Output Buffer		12.14		13.83		16.26	ns
t _{ENZL}	Enable to Pad Delay through the Output Buffer—Z to Low		12.43		14.16		16.65	ns
t _{ENZH}	Enable to Pad Delay through the Output Buffer—Z to High		12.17		13.86		16.30	ns
t _{ENLZ}	Enable to Pad Delay through the Output Buffer—Low to Z		1.73		1.74		1.75	ns
t _{ENHZ}	Enable to Pad Delay through the Output Buffer—High to Z		2.22		2.23		2.24	ns
t _{IOCLKQ}	Sequential Clock-to-Q for the I/O Input Register		0.67		0.77		0.90	ns
t _{IOCLKY}	Clock-to-output Y for the I/O Output Register and the I/O Enable Register		0.67		0.77		0.90	ns
t _{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t _{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t _{HD}	Data Input Hold		0.00		0.00		0.00	ns
t _{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t _{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.38		ns
t _{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t _{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t _{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t _{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t _{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t _{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

1.5 V LVCMOS (JESD8-11)

Low-Voltage Complementary Metal-Oxide Semiconductor for 1.5 V is an extension of the LVCMOS standard (JESD8-5) used for general-purpose 1.5 V applications. It uses a 3.3 V tolerant CMOS input buffer and a push-pull output buffer.

Table 2-29 • DC Input and Output Levels

VIL		VIH		VOL	VOH	IOL	IOH
Min., V	Max., V	Min., V	Max., V	Max., V	Min., V	mA	mA
-0.3	0.35 VCCI	0.65 VCCI	3.6	0.4	VCCI - 0.4	8 mA	-8 mA

AC Loadings

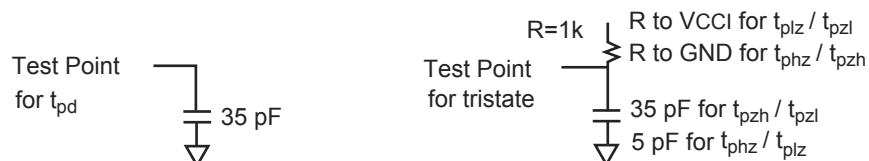


Table 2-30 • AC Test Loads

Table 2-31 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ) (V)	C _{load} (pF)
0	1.5	0.5V _{CCI}	N/A	35

Note: * Measuring Point = VTRIP

Table 2-80 • PLL Interface Signals

Signal Name	Type	User Accessible	Allowable Values	Function
RefCLK	Input	Yes		Reference Clock for the PLL
FB	Input	Yes		Feedback port for the PLL
PowerDown	Input	Yes		PLL power down control
			0	PLL powered down
			1	PLL active
DIVI[5:0]	Input	Yes	1 to 64, in unsigned binary notation offset by -1	Sets value for feedback divider (multiplier)
DIVJ[5:0]	Input	Yes		Sets value for CLK1 divider
LowFreq	Input	Yes		Input frequency range selector
			0	50–200 MHz
			1	14–50 MHz
Osc[2:0]	Input	Yes		Output frequency range selector
			XX0	400–1000 MHZ
			001	200–400 MHZ
			011	100–200 MHZ
			101	50–100 MHZ
			111	20–50 MHZ
DelayLine[4:0]	Input	Yes	–15 to +15 (increments), in signed-and-magnitude binary representation	Clock Delay (positive/negative) in increments of 250 ps, with maximum value of ± 3.75 ns
FBMuxSel	Input	No		Selects the source for the feedback input
REFSEL	Input	No		Selects the source for the reference clock
OUTSEL	Input	No		Selects the source for the routed net output
PLLSEL	Input	No		ROOTSEL & PLLSEL are used to select the source of the global clock network
ROOTSEL	Input	No		
Lock	Output	Yes		High value indicates PLL has locked
CLK1	Output	Yes		PLL clock output
CLK2	Output	Yes		PLL clock output

Note: If the input RefClk is taken outside its operating range, the outputs Lock, CLK1 and CLK2 are indeterminate.

Clock Skew Minimization

Figure 2-56 indicates how feedback from the clock network can be used to create minimal skew between the distributed clock network and the input clock. The input clock is fed to the reference clock input of the PLL. The output clock (CLK2) feeds a routed clock network. The feedback input to the PLL uses a clock input delayed by a routing network. The PLL then adjusts the phase of the input clock to match the delayed clock, thus providing nearly zero effective skew between the two clocks. Refer to the *Axcelerator Family PLL and Clock Management* application note for more information.

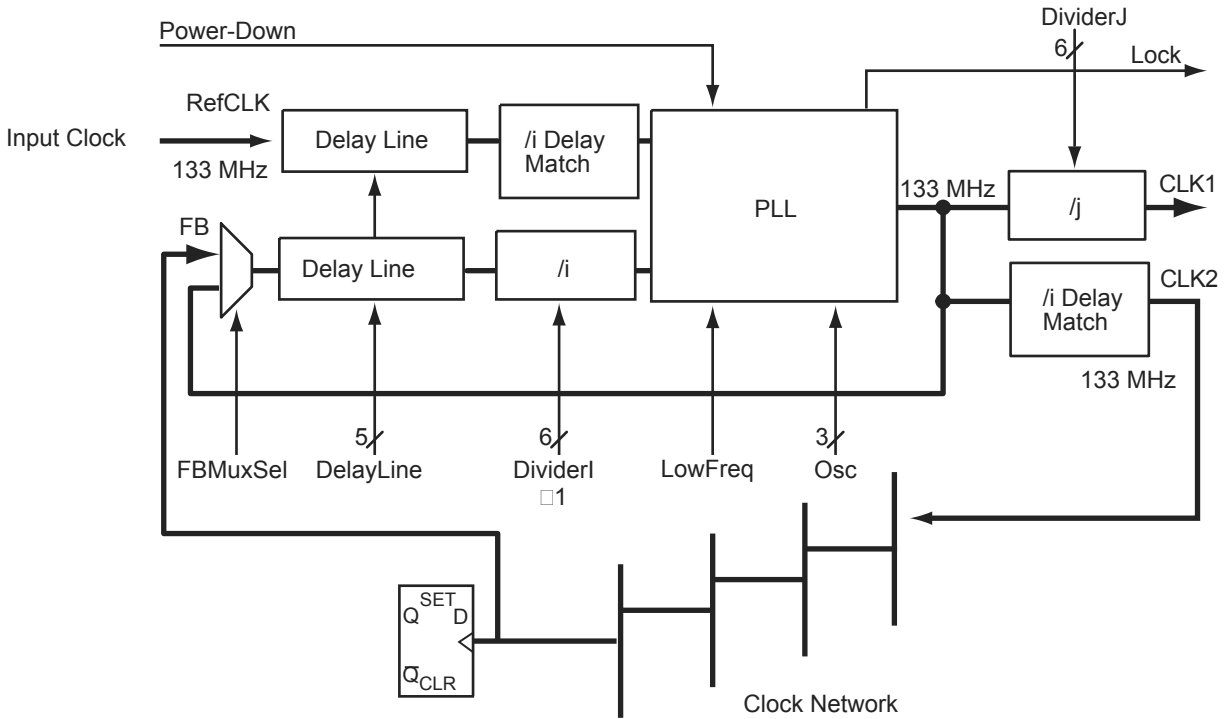


Figure 2-56 • Using the PLL for Clock Deskewing

Timing Characteristics

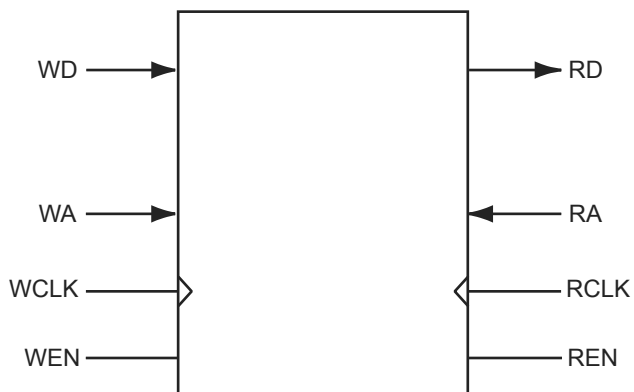


Figure 2-58 • SRAM Model

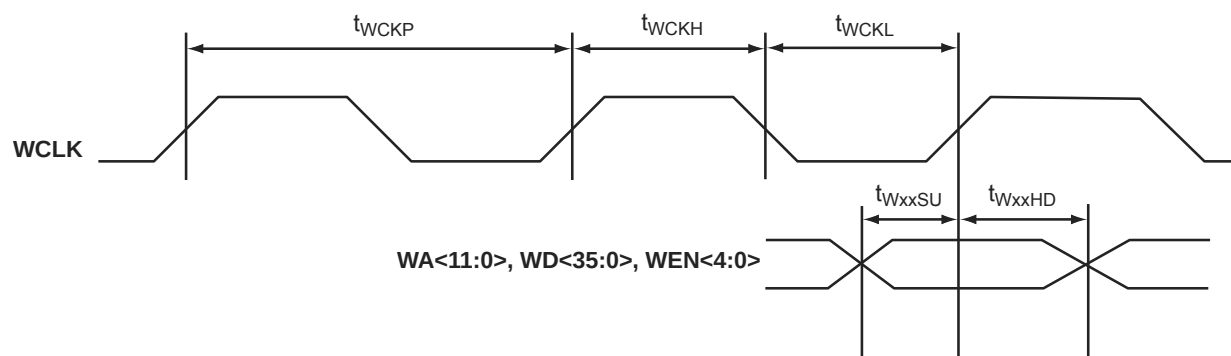


Figure 2-59 • RAM Write Timing Waveforms

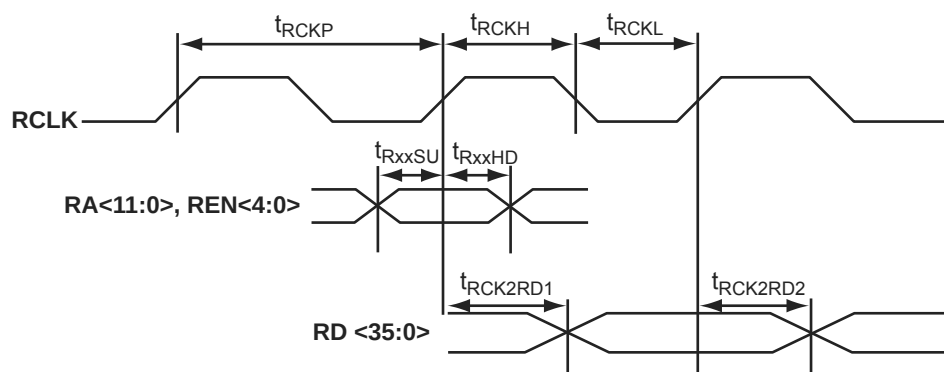


Figure 2-60 • RAM Read Timing Waveforms

Table 2-99 • Two FIFO Blocks Cascaded
Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C

		–2 Speed		–1 Speed		Std Speed		Units
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	
FIFO Module Timing								
t _{WSU}	Write Setup		13.75		15.66		18.41	ns
t _{WHD}	Write Hold		0.00		0.00		0.00	ns
t _{WCKH}	WCLK High		0.75		0.75		0.75	ns
t _{WCKL}	WCLK Low		1.76		1.76		1.76	ns
t _{WCKP}	Minimum WCLK Period	2.51		2.51		2.51		ns
t _{RSU}	Read Setup		14.33		16.32		19.19	ns
t _{RHD}	Read Hold		0.00		0.00		0.00	ns
t _{RCKH}	RCLK High		0.73		0.73		0.73	ns
t _{RCKL}	RCLK Low		1.89		1.89		1.89	ns
t _{RCKP}	Minimum RCLK period	2.62		2.62		2.62		ns
t _{CLRHF}	Clear High		0.00		0.00		0.00	ns
t _{CLR2FF}	Clear-to-flag (EMPTY/FULL)		1.92		2.18		2.57	ns
t _{CLR2AF}	Clear-to-flag (AEMPTY/AFULL)		4.39		5.00		5.88	ns
t _{CK2FF}	Clock-to-flag (EMPTY/FULL)		2.13		2.42		2.85	ns
t _{CK2AF}	Clock-to-flag (AEMPTY/AFULL)		5.04		5.75		6.75	ns
t _{RCK2RD1}	RCLK-To-OUT (Pipelined)		1.43		1.63		1.92	ns
t _{RCK2RD2}	RCLK-To-OUT (Nonpipelined)		2.26		2.58		3.03	ns

Note: Timing data for these two cascaded FIFO blocks uses a depth of 8,192. For all other combinations, use Microsemi's timing software.

Table 2-100 • Four FIFO Blocks Cascaded
Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C

		–2 Speed		–1 Speed		Std Speed		Units
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	
FIFO Module Timing								
t _{WSU}	Write Setup		14.60		16.63		19.55	ns
t _{WHD}	Write Hold		0.00		0.00		0.00	ns
t _{WCKH}	WCLK High		0.75		0.75		0.75	ns
t _{WCKL}	WCLK Low		2.51		2.51		2.51	ns
t _{WCKP}	Minimum WCLK Period	3.26		3.26		3.26		ns
t _{RSU}	Read Setup		15.27		17.39		20.44	ns
t _{RHD}	Read Hold		0.00		0.00		0.00	ns
t _{RCKH}	RCLK High		0.73		0.73		0.73	ns
t _{RCKL}	RCLK Low		2.96		2.96		2.96	ns
t _{RCKP}	Minimum RCLK period	3.69		3.69		3.69		ns
t _{CLRHF}	Clear High		0.00		0.00		0.00	ns
t _{CLR2FF}	Clear-to-flag (EMPTY/FULL)		1.92		2.18		2.57	ns
t _{CLR2AF}	Clear-to-flag (AEMPTY/AFULL)		4.39		5.00		5.88	ns
t _{CK2FF}	Clock-to-flag (EMPTY/FULL)		2.13		2.42		2.85	ns
t _{CK2AF}	Clock-to-flag (AEMPTY/AFULL)		5.04		5.75		6.75	ns
t _{RCK2RD1}	RCLK-To-OUT (Pipelined)		2.36		2.69		3.16	ns
t _{RCK2RD2}	RCLK-To-OUT (Nonpipelined)		2.83		3.23		3.79	ns

Note: Timing data for these four cascaded FIFO blocks uses a depth of 16,384. For all other combinations, use Microsemi's timing software.

BG729		BG729		BG729	
AX1000 Function	Pin Number	AX1000 Function	Pin Number	AX1000 Function	Pin Number
IO54PB1F5	E20	IO72PB2F6	J23	IO91NB2F8	N25
IO55NB1F5	E21	IO73NB2F6	H24	IO91PB2F8	N24
IO55PB1F5	D21	IO73PB2F6	H23	IO92NB2F8	N27
IO56NB1F5	H19	IO74NB2F7	L21	IO92PB2F8	N26
IO56PB1F5	G19	IO74PB2F7	K21	IO93NB2F8	P26
IO57NB1F5	D22	IO75NB2F7	G27	IO93PB2F8	P27
IO57PB1F5	C22	IO75PB2F7	F27	IO94NB2F8	N19
IO58NB1F5	B23	IO76NB2F7	K23	IO94PB2F8	N20
IO58PB1F5	A23	IO76PB2F7	K22	IO95NB2F8	P23
IO59NB1F5	D23	IO77NB2F7	H26	IO95PB2F8	P22
IO59PB1F5	C23	IO77PB2F7	H25	Bank 3	
IO60NB1F5	G21	IO78NB2F7	K25	IO96NB3F9	P25
IO60PB1F5	G20	IO78PB2F7	K24	IO96PB3F9	P24
IO61NB1F5	E23	IO79NB2F7	J26	IO97NB3F9	R26
IO61PB1F5	E22	IO79PB2F7	J25	IO97PB3F9	R27
IO62NB1F5	F22	IO80NB2F7	M20	IO98NB3F9	P21
IO62PB1F5	F21	IO80PB2F7	L20	IO98PB3F9	P20
IO63NB1F5	H20	IO81NB2F7	J27	IO99NB3F9	R24
IO63PB1F5	J19	IO81PB2F7	H27	IO99PB3F9	R25
Bank 2		IO82NB2F7	L23	IO100NB3F9	T26
IO64NB2F6	J21	IO82PB2F7	L22	IO100PB3F9	T27
IO64PB2F6	H21	IO83NB2F7	L25	IO101NB3F9	T24
IO65NB2F6	F24	IO83PB2F7	L24	IO101PB3F9	T25
IO65PB2F6	F23	IO84NB2F7	N21	IO102NB3F9	R20
IO66NB2F6	F26	IO84PB2F7	M21	IO102PB3F9	R21
IO66PB2F6	F25	IO85NB2F8	K27	IO103NB3F9	R23
IO67NB2F6	E26	IO85PB2F8	K26	IO103PB3F9	R22
IO67PB2F6	E25	IO86NB2F8	M23	IO104NB3F9	U26
IO68NB2F6	J22	IO86PB2F8	M22	IO104PB3F9	U27
IO68PB2F6	H22	IO87NB2F8	M25	IO105NB3F9	U24
IO69NB2F6	G24	IO87PB2F8	M24	IO105PB3F9	U25
IO69PB2F6	G23	IO88NB2F8	L27	IO106NB3F9	R19
IO70NB2F6	K20	IO88PB2F8	L26	IO106PB3F9	P19
IO70PB2F6	J20	IO89NB2F8	M27	IO107NB3F10	V26
IO71NB2F6	G26	IO89PB2F8	M26	IO107PB3F10	V27
IO71PB2F6	G25	IO90NB2F8	N23	IO108NB3F10	T23
IO72NB2F6	J24	IO90PB2F8	N22	IO108PB3F10	T22

FG484	
AX1000 Function	Pin Number
IO167PB5F15	AA12
IO169NB5F15	AA9
IO169PB5F15	AA10
IO170NB5F15	AB9
IO170PB5F15	AB10
IO171NB5F16	W8
IO171PB5F16	W9
IO172NB5F16	Y8
IO172PB5F16	Y9
IO173NB5F16	U8
IO173PB5F16	U9
IO174NB5F16	AA7
IO174PB5F16	AA8
IO175NB5F16	AB5
IO175PB5F16	AB6
IO176NB5F16	AA5
IO176PB5F16	AA6
IO177NB5F16	AA4
IO177PB5F16	AB4
IO178NB5F16	Y6
IO178PB5F16	Y7
IO179NB5F16	T7
IO179PB5F16	T8
IO180NB5F16	W6
IO180PB5F16	W7
IO181NB5F17	Y4
IO181PB5F17	Y5
IO184NB5F17	AB7
IO187NB5F17	V3
IO187PB5F17	W3
IO188NB5F17	V4
IO188PB5F17	W5
IO192NB5F17	V6
IO192PB5F17	V7
Bank 6	

FG484	
AX1000 Function	Pin Number
IO194NB6F18	V2
IO194PB6F18	W2
IO195NB6F18	U5
IO195PB6F18	T5
IO200NB6F18	T4
IO200PB6F18	U4
IO201NB6F18	P6
IO201PB6F18	R6
IO203NB6F19	U2
IO204NB6F19	T3
IO204PB6F19	U3
IO205NB6F19	P5
IO205PB6F19	R5
IO208NB6F19	V1
IO208PB6F19	W1
IO209NB6F19	P7
IO209PB6F19	R7
IO212NB6F19	P4
IO212PB6F19	R4
IO214NB6F20	P3
IO214PB6F20	R3
IO215NB6F20	M6
IO215PB6F20	N6
IO216NB6F20	R2
IO216PB6F20	T2
IO217NB6F20	T1
IO217PB6F20	U1
IO219NB6F20	M5
IO219PB6F20	N5
IO220NB6F20	P1
IO220PB6F20	R1
IO221NB6F20	N2
IO221PB6F20	P2
IO222NB6F20	M3
IO222PB6F20	N3

FG484	
AX1000 Function	Pin Number
IO223NB6F20	M7
IO223PB6F20	N7
IO224NB6F20	M4
IO224PB6F20	N4
Bank 7	
IO225NB7F21	M2
IO225PB7F21	N1
IO226NB7F21	K2
IO226PB7F21	K1
IO228NB7F21	L3
IO228PB7F21	L2
IO229NB7F21	K5
IO229PB7F21	L5
IO230NB7F21	H1
IO230PB7F21	J1
IO231NB7F21	H2
IO231PB7F21	J2
IO232NB7F21	K4
IO232PB7F21	K3
IO233NB7F21	K6
IO233PB7F21	L6
IO234NB7F21	F1
IO234PB7F21	G1
IO235NB7F21	F2
IO235PB7F21	G2
IO236NB7F22	H3
IO236PB7F22	J3
IO237NB7F22	K7
IO237PB7F22	L7
IO241NB7F22	H6
IO241PB7F22	J6
IO242NB7F22	H4
IO242PB7F22	J4
IO243NB7F22	H5
IO243PB7F22	J5

FG484		FG484		FG484	
AX1000 Function	Pin Number	AX1000 Function	Pin Number	AX1000 Function	Pin Number
IO246NB7F22	F3	GND	D4	GND	V5
IO246PB7F22	G3	GND	E18	GND	W19
IO250NB7F23	F4	GND	E5	GND	W4
IO250PB7F23	G4	GND	G18	GND	Y20
IO253NB7F23	G5	GND	H15	GND	Y3
IO253PB7F23	G6	GND	H8	GND/LP	G7
IO254NB7F23	D1	GND	J14	PRA	G11
IO254PB7F23	E1	GND	J9	PRB	F11
IO257NB7F23	F5	GND	K10	PRC	T12
IO257PB7F23	E4	GND	K11	PRD	U12
Dedicated I/O		GND	K12	TCK	G8
VCCDA	H7	GND	K13	TDI	F9
GND	A1	GND	L1	TDO	F7
GND	A11	GND	L10	TMS	F6
GND	A12	GND	L11	TRST	F8
GND	A2	GND	L12	VCCA	G17
GND	A21	GND	L13	VCCA	J10
GND	A22	GND	L22	VCCA	J11
GND	AA1	GND	M1	VCCA	J12
GND	AA2	GND	M10	VCCA	J13
GND	AA21	GND	M11	VCCA	J7
GND	AA22	GND	M12	VCCA	K14
GND	AB1	GND	M13	VCCA	K9
GND	AB11	GND	M22	VCCA	L14
GND	AB12	GND	N10	VCCA	L9
GND	AB2	GND	N11	VCCA	M14
GND	AB21	GND	N12	VCCA	M9
GND	AB22	GND	N13	VCCA	N14
GND	B1	GND	P14	VCCA	N9
GND	B2	GND	P9	VCCA	P10
GND	B21	GND	R15	VCCA	P11
GND	B22	GND	R8	VCCA	P12
GND	C20	GND	U16	VCCA	P13
GND	C3	GND	U6	VCCA	T6
GND	D19	GND	V18	VCCA	U17

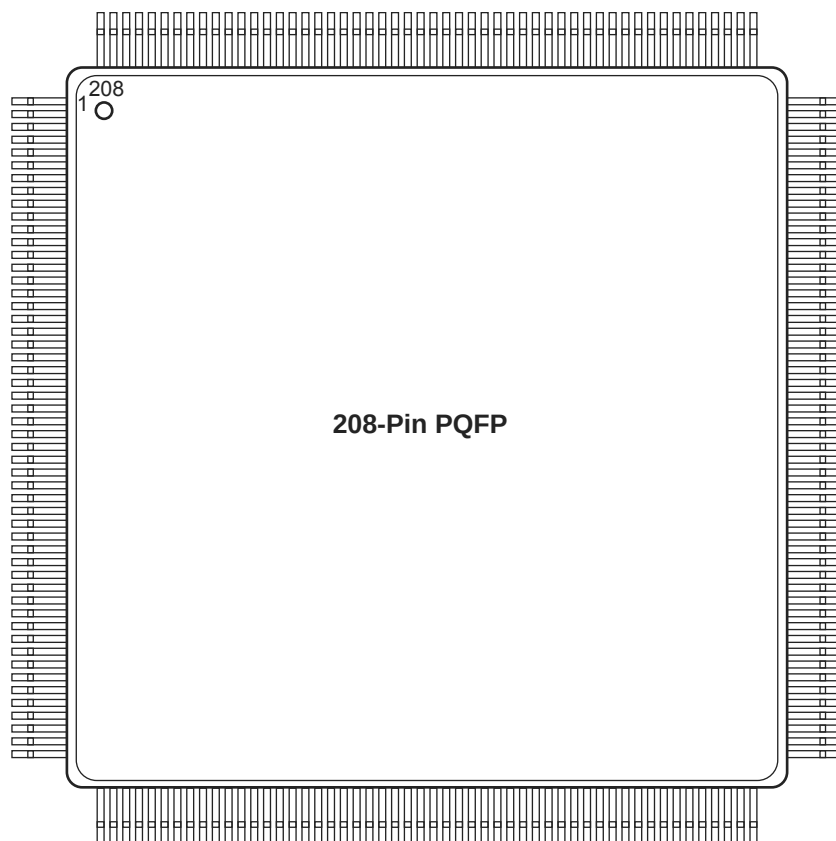
FG896	
AX2000 Function	Pin Number
IO180PB4F16	AG24
IO181NB4F17	AK24
IO181PB4F17	AK25
IO182NB4F17	AD22
IO182PB4F17	AC22
IO183NB4F17	AF22
IO183PB4F17	AF23
IO184NB4F17	AE21
IO184PB4F17	AE22
IO185NB4F17	AJ23
IO185PB4F17	AJ24
IO187NB4F17	AH22
IO187PB4F17	AH23
IO188NB4F17	AD21
IO188PB4F17	AC21
IO189PB4F17	AK22
IO190NB4F17	AF20
IO190PB4F17	AF21
IO191NB4F17	AG21
IO191PB4F17	AG22
IO192NB4F17	AE19
IO192PB4F17	AE20
IO195NB4F18	AK21
IO195PB4F18	AJ21
IO196NB4F18	AD19
IO196PB4F18	AD20
IO197NB4F18	AJ20
IO197PB4F18	AK20
IO198NB4F18	AC19
IO198PB4F18	AC20
IO199NB4F18	AG19
IO199PB4F18	AG20
IO200NB4F18	AH19
IO200PB4F18	AH20
IO201NB4F18	AK19

FG896	
AX2000 Function	Pin Number
IO201PB4F18	AJ19
IO202NB4F18	AC18
IO202PB4F18	AB18
IO206NB4F19	AE18
IO206PB4F19	AD18
IO207NB4F19	AJ17
IO207PB4F19	AJ18
IO208NB4F19	AE17
IO208PB4F19	AD17
IO209NB4F19	AK17
IO210NB4F19	AC17
IO210PB4F19	AB17
IO211NB4F19	AJ16
IO211PB4F19	AK16
IO212NB4F19/CLKEN	AG18
IO212PB4F19/CLKEP	AH18
IO213NB4F19/CLKFN	AG16
IO213PB4F19/CLKFP	AG17
Bank 5	
IO214NB5F20/CLKGN	AG14
IO214PB5F20/CLKGP	AG15
IO215NB5F20/CLKHN	AG13
IO215PB5F20/CLKHP	AH13
IO216NB5F20	AB14
IO216PB5F20	AC15
IO217NB5F20	AK15
IO217PB5F20	AJ15
IO218NB5F20	AE14
IO218PB5F20	AD14
IO219NB5F20	AK14
IO219PB5F20	AJ14
IO222NB5F20	AB13
IO222PB5F20	AC14
IO223NB5F21	AJ12
IO223PB5F21	AJ13

FG896	
AX2000 Function	Pin Number
IO225NB5F21	AH11
IO225PB5F21	AH12
IO226NB5F21	AC13
IO226PB5F21	AD13
IO227NB5F21	AE12
IO227PB5F21	AE13
IO228NB5F21	AG11
IO228PB5F21	AG12
IO229NB5F21	AK11
IO229PB5F21	AK12
IO230NB5F21	AC12
IO230PB5F21	AD12
IO232NB5F21	AE11
IO232PB5F21	AF11
IO233NB5F21	AJ10
IO233PB5F21	AJ11
IO234NB5F21	AC11
IO234PB5F21	AD11
IO236NB5F22	AK9
IO236PB5F22	AK10
IO237NB5F22	AG9
IO237PB5F22	AG10
IO238NB5F22	AF9
IO238PB5F22	AF10
IO239NB5F22	AH8
IO239PB5F22	AH9
IO240NB5F22	AC10
IO240PB5F22	AD10
IO242NB5F22	AE9
IO242PB5F22	AE10
IO243NB5F22	AJ7
IO243PB5F22	AJ8
IO244NB5F22	AK6
IO244PB5F22	AK7
IO245NB5F23	AF8

FG1152		FG1152		FG1152	
AX2000 Function	Pin Number	AX2000 Function	Pin Number	AX2000 Function	Pin Number
GND	N1	GND	U19	NC	A26
GND	N13	GND	U20	NC	AB2
GND	N22	GND	U21	NC	AB33
GND	N34	GND	U30	NC	AC34
GND	P14	GND	U5	NC	AD3
GND	P15	GND	V14	NC	AD34
GND	P16	GND	V15	NC	AE31
GND	P17	GND	V16	NC	AE33
GND	P18	GND	V17	NC	AE34
GND	P19	GND	V18	NC	AF1
GND	P20	GND	V19	NC	AF34
GND	P21	GND	V20	NC	AG2
GND	R14	GND	V21	NC	AG4
GND	R15	GND	V30	NC	AH1
GND	R16	GND	V5	NC	AH2
GND	R17	GND	W14	NC	AH31
GND	R18	GND	W15	NC	AH32
GND	R19	GND	W16	NC	AH34
GND	R20	GND	W17	NC	AJ1
GND	R21	GND	W18	NC	AJ2
GND	R3	GND	W19	NC	AJ3
GND	R32	GND	W20	NC	AJ31
GND	T14	GND	W21	NC	AJ32
GND	T15	GND	Y14	NC	AJ33
GND	T16	GND	Y15	NC	AJ34
GND	T17	GND	Y16	NC	AJ4
GND	T18	GND	Y17	NC	AL29
GND	T19	GND	Y18	NC	AM19
GND	T20	GND	Y19	NC	AM7
GND	T21	GND	Y20	NC	AN13
GND	U14	GND	Y21	NC	AN17
GND	U15	GND	Y3	NC	AN25
GND	U16	GND	Y32	NC	AN27
GND	U17	GND/LP	G6	NC	AN8
GND	U18	NC	A17	NC	AP17

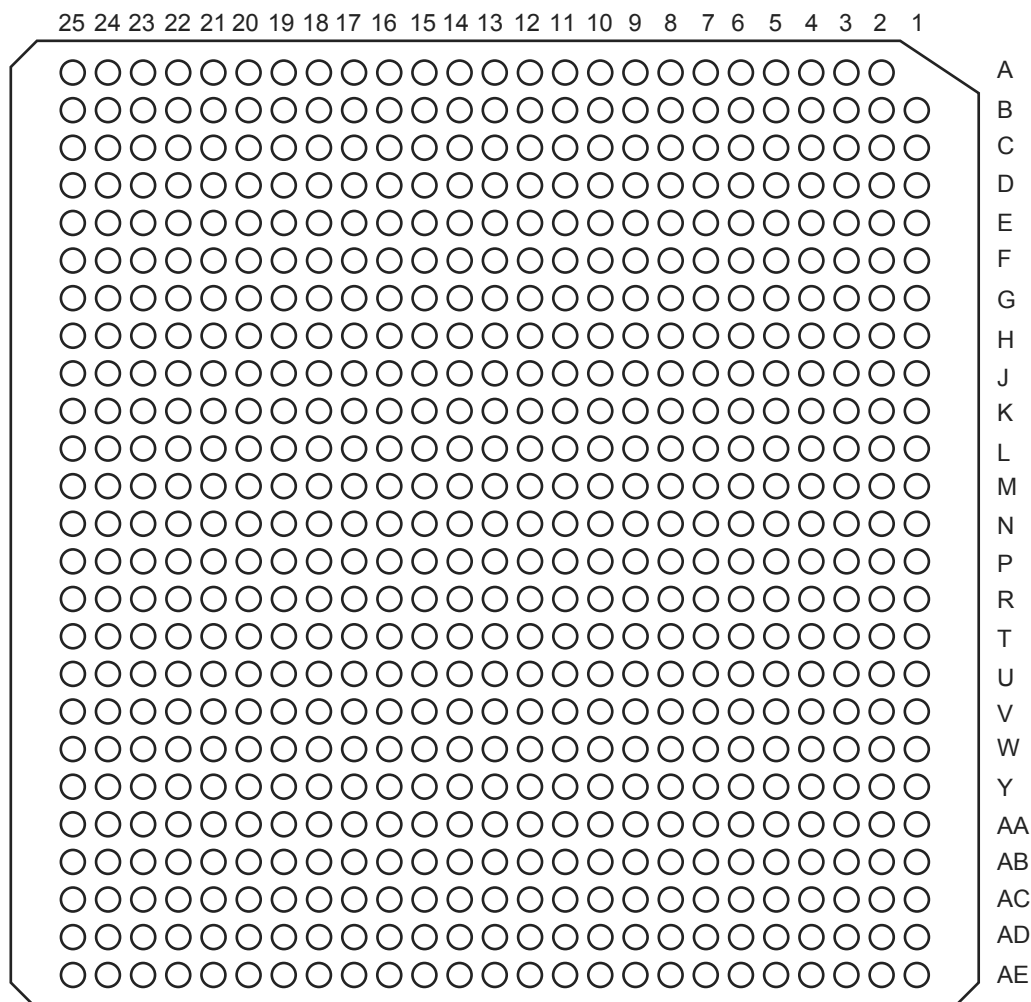
PQ208



Note

For Package Manufacturing and Environmental information, visit Resource center at <http://www.microsemi.com/soc/products/rescenter/package/index.html>.

CG624



Note

For Package Manufacturing and Environmental information, visit Resource center at <http://www.microsemi.com/soc/products/rescenter/package/index.html>.

CG624	
AX2000 Function	Pin Number
VCCIB2	D23
VCCIB2	E22
VCCIB2	K17
VCCIB2	L17
VCCIB2	M16
VCCIB3	AA22
VCCIB3	AB23
VCCIB3	AC24
VCCIB3	AC25
VCCIB3	P16
VCCIB3	R17
VCCIB3	T17
VCCIB4	AB21
VCCIB4	AC22
VCCIB4	AD23
VCCIB4	AE23
VCCIB4	T14
VCCIB4	U15
VCCIB4	U16
VCCIB5	AB5
VCCIB5	AC4
VCCIB5	AD3
VCCIB5	AE3
VCCIB5	T12
VCCIB5	U10
VCCIB5	U11
VCCIB6	AA4
VCCIB6	AB3
VCCIB6	AC1
VCCIB6	AC2
VCCIB6	P10
VCCIB6	R9

Note: **Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.*

CG624	
AX2000 Function	Pin Number
VCCIB6	T9
VCCIB7	C1
VCCIB7	C2
VCCIB7	D3
VCCIB7	E4
VCCIB7	K9
VCCIB7	L9
VCCIB7	M10
VCCPLA	E12
VCCPLB	J12
VCCPLC	E14
VCCPLD	H14
VCCPLE	Y14
VCCPLF	U14
VCCPLG	Y12
VCCPLH	U12
VCOMPLA	F12
VCOMPLB	H12
VCOMPLC	F14
VCOMPLD	J14
VCOMPLE	AA14
VCOMPLF	V14
VCOMPLG	AA12
VCOMPLH	V12
VPUMP	E20

Note: **Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.*